

10/022, 716

L Number	Hits	Search Text	DB	Time stamp
1	1	("5059264").PN.	USPAT	2004/01/23 15:01
2	1	("4587141").PN.	USPAT	2004/01/23 15:12
3	4470	((427/258) or (427/369) or (427/370) or (427/371) or (427/407.1) or (427/408) or (427/412.2)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; EPO; JPO; DERWENT	2004/01/23 15:12
4	52	((wood wooden cellulosic fiber\$1board chip\$1board partcile\$1board hard\$1board flake\$1board strand\$1board wafer\$1board) with coat\$3) same ((press\$3 near3 coat\$3) (heat\$3 near3 press\$3)) same (seal\$4)		2004/01/23 15:12

WPF 1/23/2004